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Datasheet for:

SDHC SD Card

PSSD3xxxxCxxxxxE

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Revision History

Date	Revision	Description	Checked by
2/21/18	Α	Initial release with revised format	

Ordering Information for the SDHC SD Card

VikingPart#	Interface	Temp	GB	Client/Ent	NAND
VTSD3032GCCBMTLE	SD Card	(0to+70'c)	32GB (SDHC)	Ent	TSB 15nm MLC
VTSD3064GCCAMTLE	SD Card	(0to+70'c)	64GB (SDXC)	Ent	TSB 15nm MLC
VTSD3128GCCZMTLE	SD Card	(0to+70'c)	128GB (SDXC)	Ent	TSB 15nm MLC

Notes:

- 1. Contact Viking for availability date
- 2. The lowercase letters x,y and z are wildcard characters that indicate product or customer specific information
- 3. Refer to the Viking part number coversheet or PN decoder for details.
- 4. Based on FLASH Entry SD 3.0 Toshiba MLC NAND SDHC, XC, UHS-?/U3, class10

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1 Introduction

This data sheet describes the specifications of the SDHC Card, a Memory Card of Small and Thin with SDMI compliant Security method. (SDMI: Secure Digital Music Initiative) Contents in the Card can be protected by CPRM based security. This contents security can be accomplished by SDHC Card, host, and security application software combinations.

1.1 FEATURES

Table 1-1: Features

Media Format				
SD Memory Card Standard Security Functions	Compliant with the SD Memory Card Standard Ver. 4.20 SD Security Specification Ver.3.00 Compliant (CPRM Based) *CPRM: Contents Protection for Recording Media Specification			
Logical Format	SD File System Specification Ver.3.00 Compliant SDHC Card DOS-FAT32			
Electrical Features				
Operating Voltage SD Interface	VDD = 2.7V(min), 3.3V(Typ), 3.6V(max) SD Card Interface (SD: 4 or 1bit) SPI Mode Compatible Compliant with the SD Physical layer Ver. 4.20			
Physical Features Physical Package size /Mass	L: 32, W: 24, T: 2.1 (mm), Weight: 2g (typ.) SD Physical Layer Specification Ver.4.20 Compliant Case Material PC+ABS			
Durability RoHS	Compliant with SD Physical Layer Specification Ver.4.20 and Standard Size SD Card Mechanical Addendum Version 4.20. Compliant with RoHS regulations (DIRECTIVE 2002/95/EU)			



Figure 1-1: Top View

2 SD Card Standards Compatibility

This SD Memory Card Specification is compliant with:

- PHYSICAL LAYER SPECIFICATION Ver.4.20 (Part1) (Except for Mechanical Specification)
- FILE SYSTEM SPECIFICATION Ver.3.00. (Part2)
- SECURITY SPECIFICATION Ver.3.00. (Part3)
- Standard Size SD Card Mechanical Addendum Version 4.10

3 Physical Characteristics

3.1 Environmental Characteristics

The standard Operation Conditions are:

- Absolute Maximum Temperature Range
 Ta = -25 to +85°C
- Humidity less than RH = 95 %, Non condensed
 Ta = 25°C

The standard Storage Conditions are:

- Maximum Temperature Range: Tstg = -40 to +85°C
- Humidity less than RH = 93%, Non condensed
 Ta = 40°C

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3.2 Physical Characteristics

Mechanical Write Protect Switch

A mechanical sliding tab on the side of the card can be used as a write protect switch. The host system shall be responsible for this function.

The card is in a "Write Protected" status when the tab is located on the "Lock " position. The host system shall not write nor format the card in this status.

The card is in "Write Enabled" status when the tab is moved to the opposite position (Un-Lock). (Please refer the figures below for the tab polarity.)

Please slide the tab until a dead end (stopped position). The tab is set on the "Write Enabled" position when it is shipped.

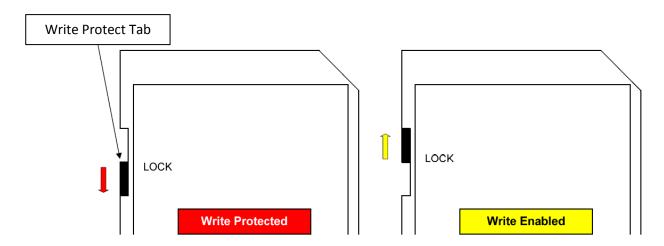


Figure 3-1: Write Protect Tab Polarity (Front View)

4 Electrical Interface

4.1 Pin Assignment

The table below describes the pin assignment of the SDHC card. The following figure describes the pin assignment of the SDHC card. Please refer the detail descriptions by SD Card Physical Layer Specification.

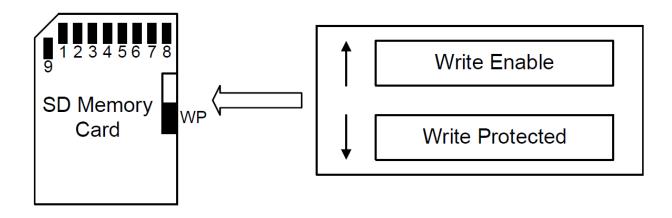


Figure 4-1: SD Card Pin Assignment (Back view of the Card)

Table 4-1: SD Card Pin Assignment

	SD Mode				SPI N	Mode
Pin	Name	IO Type	Description	Name	ІО Туре	Description
1	CD/ DAT3	I/O/ PP	Card Detect/ Data Line[Bit3]	cs	I	Chip Select (Negative True)
2	CMD	PP	Command/Response	DI	I	Data In
3	Vss1	S	Ground	Vss	S	Ground
4	Vdd	S	Supply Voltage	Vdd	S	Supply Voltage
5	CLK	I	Clock	SCLK	I	Clock
6	Vss2	S	Ground	Vss2	S	Ground
7	DAT0	I/O/PP	Data Line[Bit0]	DO	O/PP	Data Out
8	DAT1	I/O/PP	Data Line[Bit1]	RSV	_	Reserved(*)
9	DAT2	I/O/PP	Data Line[Bit2]	RSV	_	Reserved(*)

Notes:

S: Power Supply

O: Output using push-pull drivers

4.2 SD Card Bus Topology

The device supports two alternative communication protocols: SD and SPI Bus Mode. It is as same as standard SD memory card. Host System can choose either one of modes. Same Data of the device can read and write by both modes. SD Mode allows the 4-bit high performance data transfer. SPI Mode allows easy and common interface for SPI channel. The disadvantage of this mode is loss of performance, relatively to the SD mode.

I: Input

PP: I/O using push-pull drivers

^(*) These signals should be pulled up by host side with 10-100k ohm resistance in the SPI Mode.

4.2.1 SD Bus Mode protocol

The SD bus allows the dynamic configuration of the number of data line from 1 to 4 Bidirectional data signal. After power up by default, the Device will use only DATO. After initialization, host can change the bus width. Multiplied SD cards connections are available to the host. Common VDD, VSS and CLK signal connections are available in the multiple connections. However, Command, Respond and Data lined (DATO-DAT3) shall be divided for each card from host. This feature allows easy tradeoff between hardware cost and system performance. Communication over the SD bus is based on command and data bit stream initiated by a start bit and terminated by stop bit.

Command:

Commands are transferred serially on the CMD line. A command is a token to starts an operation from host to the card. Commands are sent to an addressed single card (addressed Command) or to all connected cards (Broad cast command).

Response:

Responses are transferred serially on the CMD line. A response is a token to answer to a previous received command. Responses are sent from an addressed single card or from all connected cards.

Data:

Data can be transfer from the card to the host or vice versa. Data is transferred via the data lines.

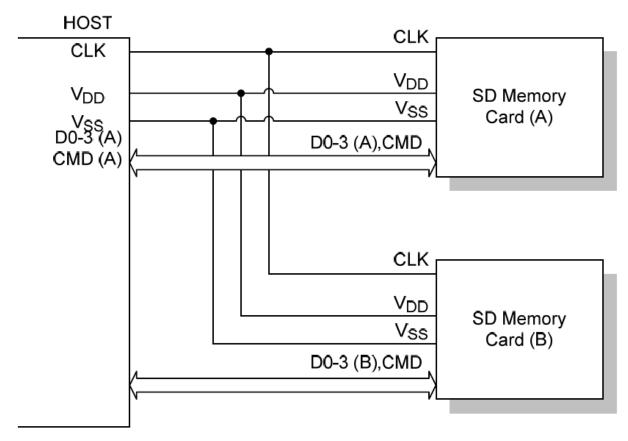


Figure 4-2: Bus Connection Diagram (SD Mode)

CLK Host card Clock signal

CMD Bi-directional Command/ Response Signal

DAT0 - DAT3 4 Bi-directional data signal

VDD Power supply

VSS GND

Table 4-2: SD Mode Command Set (+ = Implemented, - = Not Implemented)

CMD Index	Abbreviation	Implementation	Note
CMD0	GO_IDLE_STATE	+	
CMD2	ALL_SEND_CID	+	
CMD3	SEND_RELATIVE_ADDR	+	
CMD4	SET_DSR	-	DSR Register is not implemented.
CMD6	SWITCH_FUNC	+	
CMD7	SELECT/DESELECT_CARD	+	
CMD8	SEND_IF_COND	+	
CMD9	SEND_CSD	+	
CMD10	SEND_CID	+	
CMD11	VOLTAGE_SWITCH	+	UHS-I mode

CMD12 STOP_TRANSMISSION + CMD13 SEND_STATUS + CMD15 GO_INACTIVE_STATE + CMD16 SET_BLOCKLEN + CMD17 READ_SINGLE_BLOCK + CMD18 READ_MULTIPLE_BLOCK + CMD19 SEND_TUNING_PATTERN + UHS-I mode CMD20 SPEED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + For SDHC/SDXC CMD24 WRITE_BLOCK + CMD24 CMD25 WRITE_MULTIPLE_BLOCK + CMD26 CMD26 Reserved for Manufacturer + CMD27 CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD31 ERASE_WR_BLK_START + CMD36 CMD32 ERASE_WR_BLK_END + This command is not specified. CMD33 ERASE + This command is not specified. CMD42<	CMD Index	Abbreviation	Implementation	Note
CMD15 GO_INACTIVE_STATE + CMD16 SET_BLOCKLEN + CMD17 READ_SINGLE_BLOCK + CMD18 READ_MULTIPLE_BLOCK + CMD19 SEND_TUNING_PATTERN + UHS-I mode CMD20 SPED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + For SDHC/SDXC CMD24 WRITE_BLOCK + CMD26 CMD25 WRITE_MULTIPLE_BLOCK + CMD27 CMD26 Reserved for Manufacturer + CMD27 CMD27 PROGRAM_CSD + Internal Write Protection is not implemented. CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD31 ERASE_WR_BLK_END + + CMD32 ERASE_WR_BLK_END + + CMD33 ERASE + + CMD42 LOCK_UNLOCK + + + <td>CMD12</td> <td>STOP_TRANSMISSION</td> <td>+</td> <td></td>	CMD12	STOP_TRANSMISSION	+	
CMD16 SET_BLOCKLEN + CMD17 READ_SINGLE_BLOCK + CMD18 READ_MULTIPLE_BLOCK + CMD19 SEND_TUNING_PATTERN + CMD20 SPEED_CLASS_CONTROL + CMD23 SET_BLOCK_COUNT + CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD31 ERASE_WR_BLK_END + CMD32 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD42 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + + CMD61 Reserved for Manufacturer <	CMD13	SEND_STATUS	+	
CMD17 READ_SINGLE_BLOCK + CMD18 READ_MULTIPLE_BLOCK + CMD19 SEND_TUNING_PATTERN + UHS-I mode CMD20 SPEED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + CMD24 CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD31 ERASE_WR_BLK_START + CMD32 ERASE_WB_BLK_START + CMD33 ERASE + CMD34 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + ACMD6 CMD61 Reserved for Manufacturer +	CMD15	GO_INACTIVE_STATE	+	
CMD18 READ_MULTIPLE_BLOCK + CMD19 SEND_TUNING_PATTERN + UHS-I mode CMD20 SPEED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + CMD24 WRITE_BLOCK + CMD24 WRITE_BLOCK + CMD26 WRITE_MULTIPLE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD32 ERASE_WR_BLK_START + + CMD32 ERASE_WR_BLK_END + + CMD32 ERASE_WR_BLK_END + + CMD42 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + This command is not specified. CMD55 APP_CMD + This command is not specified.	CMD16	SET_BLOCKLEN	+	
CMD19 SEND_TUNING_PATTERN + UHS-I mode CMD20 SPEED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + + CMD24 WRITE_BLOCK + + CMD25 WRITE_MULTIPLE_BLOCK + + CMD26 Reserved for Manufacturer + + CMD27 PROGRAM_CSD + + CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SERASE_WR_BLK_START + + CMD31 SERASE_WR_BLK_END + + CMD40 LOCK_UNLOCK + + CMD41 APP_CMD + This	CMD17	READ_SINGLE_BLOCK	+	
CMD20 SPEED_CLASS_CONTROL + For SDHC/SDXC CMD23 SET_BLOCK_COUNT + + CMD24 WRITE_BLOCK + + CMD25 WRITE_MULTIPLE_BLOCK + + CMD26 Reserved for Manufacturer + + CMD27 PROGRAM_CSD + + CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD32 ERASE_WR_BLK_START + Internal Write Protection is not implemented. CMD32 ERASE_WR_BLK_START + Internal Write Protection is not implemented. CMD32 ERASE_WR_BLK_START + Internal Write Protection is not implemented. CMD32 ERASE_WR_BLK_END + Internal Write Protection is not implemented. CMD33 ERASE_WR_BLK_END +	CMD18	READ_MULTIPLE_BLOCK	+	
CMD23 SET_BLOCK_COUNT + CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD33 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD65 APP_CMD + CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD23 SETAUS_MUS_WR_BLOCKS + ACMD23 SET_UR_BLK_ERASE	CMD19	SEND_TUNING_PATTERN	+	UHS-I mode
CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD32 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD34 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + + CMD61 Reserved for Manufacturer + + CMD62 Reserved for Manufacturer + + ACMD6 SET_BUS_WIDTH + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD23 SET_WR_BLK_ERASE_COUNT +	CMD20	SPEED_CLASS_CONTROL	+	For SDHC/SDXC
CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD32 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD60 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + + CMD61 Reserved for Manufacturer + + CMD62 Reserved for Manufacturer + + ACMD6 SET_BUS_WIDTH + + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND +	CMD23	SET_BLOCK_COUNT	+	
CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD66 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + + CMD61 Reserved for Manufacturer + + CMD62 Reserved for Manufacturer + + ACMD6 SET_BUS_WIDTH + + ACMD23 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD51		WRITE_BLOCK	+	
CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD23 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD25	WRITE_MULTIPLE_BLOCK	+	
CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - - CMD32 ERASE_WR_BLK_START + - CMD33 ERASE_WR_BLK_END + - CMD38 ERASE + - CMD42 LOCK_UNLOCK + - CMD42 LOCK_UNLOCK + - CMD55 APP_CMD + - CMD55 APP_CMD + - CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + - CMD61 Reserved for Manufacturer + - CMD62 Reserved for Manufacturer + - ACMD6 SET_BUS_WIDTH + - ACMD23 SET_WR_BLK_ERASE_COUNT + - ACMD23 SET_WR_BLK_ERASE_COUNT + -	CMD26	Reserved for Manufacturer	+	
CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - - CMD32 ERASE_WR_BLK_START + - CMD33 ERASE_WR_BLK_END + - CMD38 ERASE + - CMD42 LOCK_UNLOCK + - CMD55 APP_CMD + - CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + - CMD61 Reserved for Manufacturer + - CMD62 Reserved for Manufacturer + - ACMD6 SET_BUS_WIDTH + - ACMD23 SETATUS + - ACMD23 SET_WR_BLK_ERASE_COUNT + - ACMD41 SD_APP_OP_COND + - ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD27	PROGRAM_CSD	+	
CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD66 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + + ACMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + + ACMD23 SET_ATUS + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + + + +	CMD28	SET_WRITE_PROT	-	
CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD29	CLR_WRITE_PROT	-	Internal Write Protection is not implemented.
CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD30	SEND_WRITE_PROT	-	
CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD32	ERASE_WR_BLK_START	+	
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CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD62 Reserved for Manufacturer + ACMD63 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD52 SEND_SCR + ACMD52 SEND_SCR <td>CMD38</td> <td>ERASE</td> <td>+</td> <td></td>	CMD38	ERASE	+	
CMD56 GEN_CMD + This command is not specified. CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD41 SEND_SCR +	CMD42	LOCK_UNLOCK	+	
CMD60 Reserved for Manufacturer + CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD55	APP_CMD	+	
CMD61 Reserved for Manufacturer + CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD56	GEN_CMD	+	This command is not specified.
CMD62 Reserved for Manufacturer + ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD60	Reserved for Manufacturer	+	
ACMD6 SET_BUS_WIDTH + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	CMD61	Reserved for Manufacturer	+	
ACMD13 SD_STATUS	CMD62	Reserved for Manufacturer	+	
ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	ACMD6	SET_BUS_WIDTH	+	
ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	ACMD13	SD_STATUS	+	
ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	ACMD22	SEND_NUM_WR_BLOCKS	+	
ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR +	ACMD23	SET_WR_BLK_ERASE_COUNT	+	
ACMD51 SEND_SCR +			+	
_	ACMD42	SET_CLR_CARD_DETECT	+	
ACMD18 SECURE READ MULTI BLOCK +	ACMD51	SEND_SCR	+	
	ACMD18	SECURE_READ_MULTI_BLOCK	+	
ACMD25 SECURE_WRITE_MULTI_BLOCK +	ACMD25	SECURE_WRITE_MULTI_BLOCK	+	
ACMD26 SECURE_WRITE_MKB +	ACMD26	SECURE_WRITE_MKB	+	
ACMD38 SECURE_ERASE +	ACMD38	SECURE_ERASE	+	
ACMD43 GET_MKB +	ACMD43	GET_MKB	+	
ACMD44 GET_MID +	ACMD44	GET_MID	+	
ACMD45 SET_CER_RN1 +	ACMD45	SET_CER_RN1	+	
ACMD46 GET_CER_RN2 +	ACMD46	GET_CER_RN2	+	
ACMD47 SET_CER_RES2 +	ACMD47	SET_CER_RES2	+	
ACMD48 GET_CER_RES1 +	ACMD48	GET_CER_RES1	+	
ACMD49 CHANGE_SECURE_AREA + Notes:		CHANGE_SECURE_AREA	+	

Notes:

- CMD28, 29 and CMD30 are optional commands.
- CMD4 is not implemented because DSR register (Optional Register) is not implemented.
- CMD56 is a vender specific command which is not defined in the standard card.

6.2.2 SPI Bus mode Protocol

The SPI bus allows 1 bit Data line by 2-chanel (Data In and Out). The SPI compatible mode allows the MMC Host systems to use SD card with little change. The SPI bus mode protocol is byte transfers. All the data token are multiples of the bytes (8-bit) and always byte aligned to the CS signal.

The advantage of the SPI mode is reducing the host design effort. Especially, the MMC host can be modified with little change. The disadvantage of the SPI mode is the loss of performance versus SD mode.

Caution: Please use SD Card Specification. DO NOT use MMC Specification. (For example, initialization is achieved by ACMD41, and be careful to Register. Register definition is different, especially CSD Register.)

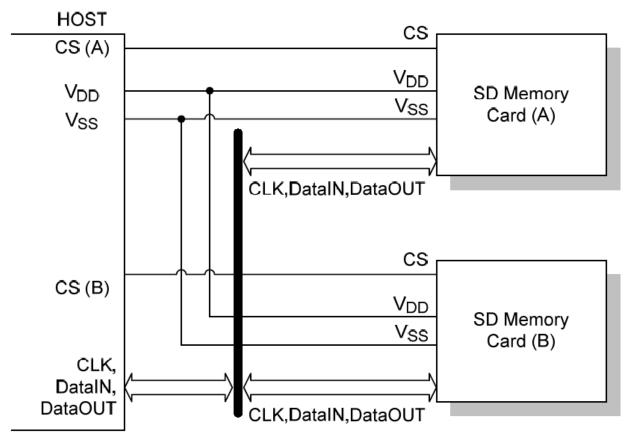


Figure 4-3: Bus Connection Diagram (SPI Mode)

CS Card Select Signal
CLK Host card Clock signal

CMD Bi-directional Command/ Response Signal

DataIN Host to card data line
DataOUT Host to card data line
VDD Power supply

VSS GND

Table 4-3: SPI Mode Command Set (+ = Implemented, - = Not Implemented)

CMD Index	Abbreviation	Implementation	Note
CMD0	GO_IDLE_STATE	+	
CMD1	SEND_OP_COND	+	Note: DO NOT USE (See UHS-I Host Initialization Flow Chart and the section called "Efficient Data Writing to SD Memory Card"
CMD6	SWITCH_FUNC	+	
CMD8	SEND_IF_COND	+	
CMD9	SEND_CSD	+	
CMD10	SEND_CID	+	
CMD12	STOP_TRANSMISSION	+	

CMD13 SEND_STATUS + CMD16 SET_BLOCKLEN + CMD17 READ_SINGLE_BLOCK + CMD24 WRITE_BLOCK + CMD25 WRITE_BLOCK + CMD26 WRITE_BLOCK + CMD27 WROMAUTIPLE_BLOCK + CMD28 WRITE_MOUTIPLE_BLOCK + CMD29 PROGRAM_CSD + CMD29 PROGRAM_CSD + CMD29 CLR_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD33 ERASE_WR_BLK_START + CMD30 BEASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD58 ERAD_CCR + CMD58 AEAD_OCR + CMD59 CRC_ON_OFF + CMD59	CMD Index	Abbreviation	Implementation	Note
CMD17 READ_SINGLE_BLOCK + CMD18 READ_MULTIPLE_BLOCK + CMD24 WRITE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD31 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD34 LOCK_UNLOCK + CMD35 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD58 READ_OCR + + CMD59 CR_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD23 SET_UR_BLK_ERASE_COUNT + + ACMD25 SET_UR_BLK_ERASE_COUNT + + <	CMD13	SEND_STATUS	+	
CMD18 READ_MULTIPLE_BLOCK + CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD33 SERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD34 LOCK_UNLOCK + CMD35 APP_CMD + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD13 SD_STATUS + + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23	CMD16	SET_BLOCKLEN	+	
CMD24 WRITE_BLOCK + CMD25 WRITE_MULTIPLE_BLOCK + CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD33 ERASE_WR_BLK_END + CMD33 ERASE + CMD34 LOCK_UNLOCK + CMD55 APP_CMD + CMD55 APP_CMD + CMD58 GEN_CMD + This command is not specified. CMD58 CRC_ON_OFF + - CMD58 CRAD_OCR + - CMD59 CRC_ON_OFF + - CMD40 Reserved for Manufacturer + - ACMD21 SET_NUM_WR_BLOCKS	CMD17	READ_SINGLE_BLOCK	+	
CMD25 WRITE_MULTIPLE_BLOCK + CMD27 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD21 SEN_JAUR_MR_BLOCKS + ACMD22 SEN_JNUM_WR_BLOCKS + ACMD23 SET_WB_LK_ERASE_COUNT + ACMD41 SET_OER_CARD_DETECT +	CMD18	READ_MULTIPLE_BLOCK	+	
CMD26 Reserved for Manufacturer + CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE_WR_BLK_END + CMD38 ERASE + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD53 APP_CMD + CMD54 APP_CMD + CMD55 APP_CMD + CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD50 Reserved for Manufacturer + ACMD21 SEND_NUM_WR_BLOCKS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT +	CMD24	WRITE_BLOCK	+	
CMD27 PROGRAM_CSD + CMD28 SET_WRITE_PROT - CMD29 CLR_WRITE_PROT - CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CL_CARD_DETECT + ACMD43 SECURE_WRITE_MULTI_BLOCK + ACMD45 SECURE_WRITE_MUS +	CMD25	WRITE_MULTIPLE_BLOCK	+	
CMD28 SET_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - Internal Write Protection is not implemented. CMD30 ERASE_WR_BLK_START + - CMD31 ERASE_WR_BLK_END + - CMD38 ERASE + - CMD42 LOCK_UNLOCK + - CMD55 APP_CMD + - CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + - CMD59 CRC_ON_OFF + - CMD59 RESERVED OR + - CMD59 RESERVED OR + - ACMD49 SET_ATTUS + - ACMD40 SEND_NUM_WR_BLOCKS + - ACMD20 SEND_NUM_WR_BLOCKS + - ACMD41 SD_APP_OP_COND + - ACMD42 SET_CR_CARD_DETECT + - ACMD43 S	CMD26	Reserved for Manufacturer	+	
CMD29 CLR_WRITE_PROT - Internal Write Protection is not implemented. CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD54 APP_CMD + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD413 SD_STATUS + + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WB_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD43 SECURE_WRITE_MULTI_BLOCK +	CMD27	PROGRAM_CSD	+	
CMD30 SEND_WRITE_PROT - CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD41 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD45 SECURE_READ_MULTI_BLOCK + ACMD45 SECURE_WRITE_MULTI_BLOCK + ACMD45 SECURE_WRITE_MKB + ACMD46 SEC_MRB + ACMD47 SET_CER_RN1 + ACMD46 SET_CER_RN2 + ACMD47 SET_CER_RES2 + </td <td>CMD28</td> <td>SET_WRITE_PROT</td> <td>-</td> <td></td>	CMD28	SET_WRITE_PROT	-	
CMD32 ERASE_WR_BLK_START + CMD33 ERASE_WR_BLK_END + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD13 SD_STATUS + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + ACMD45 SET_CLR_CARD_DETECT + ACMD45 SECURE_READ_MULTI_BLOCK + ACMD45 ACMD45 SECURE_WRITE_MKB + ACMD45 ACMD45 SECURE_WRITE_MKB + ACMD46 ACMD46 SET_MEB + ACMD46 SET_CER_RN1 + ACMD46 SET_CER_RN2 <	CMD29	CLR_WRITE_PROT	-	Internal Write Protection is not implemented.
CMD33 ERASE_WR_BLK_END + CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + CMD57 FREAD_OCR + CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD13 SD_STATUS + ACMD23 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD43 SECURE_READ_MULTI_BLOCK + ACMD45 SECURE_WRITE_MULTI_BLOCK + ACMD25 SECURE_WRITE_MKB + ACMD46 SEC_WR_ERASE + ACMD40 GET_MIB + ACMD44 GET_MID + ACMD46 GET_CER_RN2 + ACMD47	CMD30	SEND_WRITE_PROT	-	
CMD38 ERASE + CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD13 SD_STATUS + + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD43 SET_UR_CARD_DETECT + + ACMD41 SEOURE_READ_MULTI_BLOCK + + ACMD43 SECURE_WRITE_MKB + + ACMD46 SECURE_ERASE + + ACMD43 GET_MKB + + ACMD44 GET_MID + + ACMD45 SET_CER_RN1 +	CMD32	ERASE_WR_BLK_START	+	
CMD42 LOCK_UNLOCK + CMD55 APP_CMD + CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD13 SD_STATUS + + ACMD21 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD43 SEND_SCR + + ACMD40 SECURE_READ_MULTI_BLOCK + + ACMD45 SECURE_WRITE_MULTI_BLOCK + + ACMD46 SECURE_ERASE + + ACMD48 SECURE_ERASE + + ACMD49 SET_CER_RN1 + +	CMD33	ERASE_WR_BLK_END	+	
CMD55 APP_CMD + This command is not specified. CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD13 SD_STATUS + + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD41 SEND_SCR + + ACMD43 SECURE_READ_MULTI_BLOCK + + ACMD45 SECURE_WRITE_MKB + + ACMD48 SECURE_ERASE + + ACMD40 GET_MKB + + ACMD44 GET_MID + + ACMD45 SET_CER_RN1 + + ACMD46 GET_CER_RS2 + +	CMD38	ERASE	+	
CMD56 GEN_CMD + This command is not specified. CMD58 READ_OCR + + CMD59 CRC_ON_OFF + + CMD60 Reserved for Manufacturer + + ACMD13 SD_STATUS + + ACMD22 SEND_NUM_WR_BLOCKS + + ACMD23 SET_WR_BLK_ERASE_COUNT + + ACMD41 SD_APP_OP_COND + + ACMD42 SET_CLR_CARD_DETECT + + ACMD51 SEND_SCR + + ACMD51 SECURE_READ_MULTI_BLOCK + + ACMD25 SECURE_WRITE_MULTI_BLOCK + + ACMD26 SECURE_WRITE_MKB + + ACMD38 SECURE_ERASE + + ACMD43 GET_MKB + + ACMD44 GET_MID + + ACMD45 SET_CER_RN1 + + ACMD47 SET_CER_RES2 + + ACMD48 GET_CER_RES1 + + <td>CMD42</td> <td>LOCK_UNLOCK</td> <td>+</td> <td></td>	CMD42	LOCK_UNLOCK	+	
CMD58 READ_OCR + CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD18 SECURE_READ_MULTI_BLOCK + ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD28 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	CMD55	APP_CMD	+	
CMD59 CRC_ON_OFF + CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD18 SECURE_READ_MULTI_BLOCK + ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	CMD56	GEN_CMD	+	This command is not specified.
CMD60 Reserved for Manufacturer + ACMD13 SD_STATUS + ACMD22 SEND_NUM_WR_BLOCKS + ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD18 SECURE_READ_MULTI_BLOCK + ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	CMD58	READ_OCR	+	
ACMD13 SD_STATUS	CMD59	CRC_ON_OFF	+	
ACMD22 SEND_NUM_WR_BLOCKS	CMD60	Reserved for Manufacturer	+	
ACMD23 SET_WR_BLK_ERASE_COUNT + ACMD41 SD_APP_OP_COND + ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD18 SECURE_READ_MULTI_BLOCK + ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD13	SD_STATUS	+	
ACMD41 SD_APP_OP_COND	ACMD22	SEND_NUM_WR_BLOCKS	+	
ACMD42 SET_CLR_CARD_DETECT + ACMD51 SEND_SCR + ACMD18 SECURE_READ_MULTI_BLOCK + ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD23	SET_WR_BLK_ERASE_COUNT	+	
ACMD51 SEND_SCR +	ACMD41	SD_APP_OP_COND	+	
ACMD18 SECURE_READ_MULTI_BLOCK	ACMD42	SET_CLR_CARD_DETECT	+	
ACMD25 SECURE_WRITE_MULTI_BLOCK + ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD51	SEND_SCR	+	
ACMD26 SECURE_WRITE_MKB + ACMD38 SECURE_ERASE + ACMD43 GET_MKB + ACMD44 GET_MID + ACMD45 SET_CER_RN1 + ACMD46 GET_CER_RN2 + ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD18	SECURE_READ_MULTI_BLOCK	+	
ACMD38 SECURE_ERASE +	ACMD25	SECURE_WRITE_MULTI_BLOCK	+	
ACMD43 GET_MKB +	ACMD26	SECURE_WRITE_MKB	+	
ACMD44 GET_MID	ACMD38	SECURE_ERASE	+	
ACMD45 SET_CER_RN1 +	ACMD43	GET_MKB	+	
ACMD46 GET_CER_RN2 +	ACMD44	GET_MID	+	
ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD45	SET_CER_RN1	+	
ACMD47 SET_CER_RES2 + ACMD48 GET_CER_RES1 +	ACMD46	GET_CER_RN2	+	
			+	
ACMD49 CHANGE_SECURE_AREA +	ACMD48	GET_CER_RES1	+	
	ACMD49	CHANGE_SECURE_AREA	+	

Notes:

- CMD28, CMD29 and CMD30 are optional commands.
- CMD56 is a vender specific command which is not defined in the standard card.

4.3 SDHC Card Initialization

The flow chart for UHS-I hosts and the sequence of commands to perform a signal voltage switch is shown below. Red and yellow boxes are new procedures to initialize the UHS-I card.

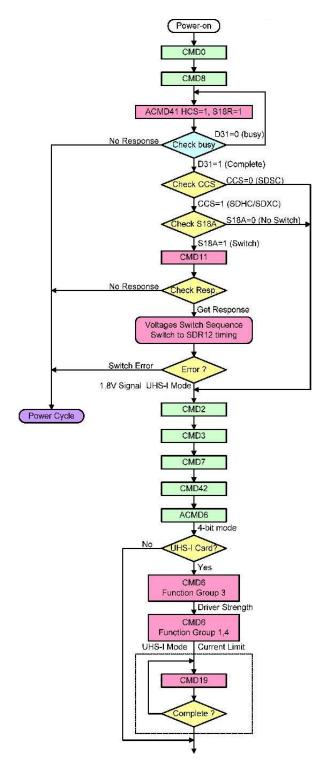


Figure 4-4: UHS-I Host Initialization Flow Chart

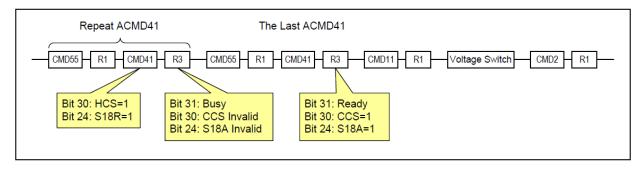


Figure 4-5: ACMD41 Timing Followed by Signal Voltage Switch Sequence

1) POWER ON: Supply Voltage for initialization.

Host System applies the perating Voltage to the card. Apply more than 74 cycles of Dummy-clock to the SD card.

2) Select operation mode (SD mode or SPI mode)

In the case of SPI mode operation, the host should drive pin 1 (CD/DAT3) of the SD Card I/F to a "Low" level. Then, issue CMD0. In the case of SD mode operation, the host should drive or detect pin 1 of the SD Card I/F (Pull up register of pin 1 is pull up to "High" normally). The card maintains selected operation mode except re-issue of CMD0 or power on below is SD mode initialization procedure.

3) Send Interface condition command (CMD8).

When the card is in the Idle state, the host shall issue CMD8 before ACMD41. In the argument, 'voltage supplied' is set to the host supply voltage and 'check pattern' is set to any 8-bit pattern. The card that accepted the supplied voltage returns R7 response. In the response, the card echoes back both the voltage range and check pattern set in the argument. If the card does not support the host supply voltage, it shall not return response and stays in the Idle state.

4) Send initialization command (ACMD41).

When the signaling level is 3.3V, the host repeats an issue ACMD41 with HCS=1 and S18R=1 until the response indicates ready. The argument (HCS and S18R) of the first ACMD41 is effective but the all the following ACMD41 should be issued with the same argument. If Bit 31 indicates ready, the host needs to check CCS and S18A. The card indicates S18A=0, which means that the voltage switch is not allowed and the host needs to use the current signaling level.

Table 4-4:S18R and S18A Combinations

Current Signaling Level	18R	S18A	Comment
0 0 1.8V signaling is not requested		1.8V signaling is not requested	
3.3V	1	0	The card does not support 1.8V signaling
	1	1	Start signal voltage switch sequence
1.8V	Χ	0	Already switched to 1.8V

5) Send voltage switch command (CMD11)

S18A=1 means that the voltage switch is allowed and host issues CMD11 to invoke voltage switch sequence. By receiving CMD11, the card returns R1 response and start voltage switch sequence. No response of CMD11 means that S18A was 0 and therefore the host should not have sent CMD11. Completion of voltage switch sequence is checked by high level of DAT[3:0]. Any bit of DAT[3:0] can be checked depends on ability of the host. The card enters UHS-I mode and card input and output timings are changed (SDR12 in default) when the voltage switch sequence is completed successfully.

6) Send ALL_SEND_CID command (CMD2) and get the Card ID (CID)

7) Send SEND RELATIVE ADDR (CMD3) and get the RCA. RCA value is randomly changed by access, not equal zero.

8) Send SELECT / DESELECT_CARD command (CMD7) and move to the transfer state. When entering tran state, CARD_IS_LOCKED status in the R1 response should be checked (it is indicated in the response of CMD7). If the CARD_IS_LOCKED status is set to 1 in the response of CMD7, CMD42 is required before ACMD6 tounlock the card. (If the card is locked, CMD42 is required to unlock the card.) If the card is unlocked, CMD42 can be skipped.

9) Send SET_BUS_WIDTH command (ACMD6).

UHS-I supports only 4-bit mode. Host shall select 4-bit mode by ACMD6. If the card is locked, host needs to unlock the card by CMD42 in 1-bit mode and then needs to issue ACMD6 to change 4-bit bus mode. Operating in 1-bit mode is not assured.

10) Set driver strength.

CMD6 mode 0 is used to query which functions the card supports, and to identify the maximum current consumption of the card under the selected functions. In case of UHS-I card, appropriate driver strength (default is Type-B buffer) is selected by CMD6 Function Group 3.

11) Set UHS-I mode current limit.

UHS-I modes (Bus Speed Mode) is selected by CMD6 Function Group

1. Current limit is selected by CMD6 Function Group 4.

Note:

Function Group 4 is defined as Current Limit switch for SDR50, SDR104, DDR50. The Current Limit does not act on the card in SDR12 and SDR25. The default value of the Current Limit is 200mA (minimum setting). Then after selecting one of SDR50, SDR104, DDR50 mode by

Function Group 1, host needs to change the Current Limit to enable the card to operate in higher performance. This value is determined by a host power supply capability to the card, heat release method taken by a host and the maximum current of a connector.

12) Tuning of sampling point

CMD19 sends a tuning block to the host to determine sampling point. In SDR50, SDR104 and DDR50 modes, if tuning of sampling point is required, CMD19 is repeatedly issued until tuning is completed. Then the Host can access the Data between the SD card as a storage device.

Application Notes:

- 1.The host shall set ACMD41 timeout to more than 1 second to abort repeat of issuing ACMD41 when the card does not indicate ready. The timeout count starts from the first ACMD41 which is set voltage window in the argument.
- 2.Once the signal voltage is switched to 1.8V, the card continues 1.8V signaling regardless of CMD0. Power cycle resets the signal voltage to 3.3V. After switching 1.8V singling, the card cannot be changed to SPI mode.
- 3. Timing to Switch Signal Voltage To change signaling level at the same time between host and card, signal voltage switch sequence is invoked by CMD11 as shown in the figure below. CMD11 is issued only when S18A=1 in the response of ACMD41.

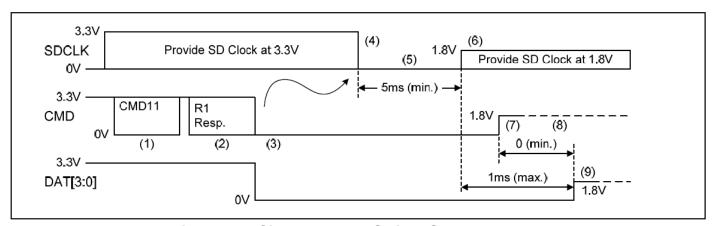


Figure 4-6: Signal Voltage Switch Sequence

Steps that the host takes to start a voltage switch sequence.

- 1. The host issues CMD11 to start voltage switch sequence.
- 2. The card returns R1 response.
- 3. The card drives CMD and DAT[3:0] to "low" immediately after the response.
- 4. The host stops supplying SDCLK. The card shall start switching voltage after host stops SDCLK. The time to stop SDCLK is not specified. The host can detect whether the sequence starts by checking signal level of either one of CMD, DAT[3:0]. What signal should be checked will depend on the ability of the host. If low level is not detected, the host should abort the sequence and execute power cycle.
- 5. 1.8V output of voltage regulator in card shall be stable within 5ms. The Host keeps SDCLK low at least 5ms. This means that 5ms is the maximum for the card and the minimum for the host.
- 6. After 5ms from (step 4) and host voltage regulator is stable, the host starts providing SDCLK at 1.8V.

- The card can check whether SDCLK voltage is 1.8V.
- 7. By detecting SDCLK, the card drives CMD to high at 1.8V for at least one clock and then stops driving (tri-state). CMD is triggered by rising edge of SDCLK (SDR timing).
- 8. The card can check whether host drives CMD to 1.8V through the host pull-up resister.
- 9. If switching to 1.8V signaling is completed successfully, the card drives DAT[3:0] to high at 1.8V at least one clock and then stop driving (tri-state). DAT[3:0] is triggered by rising edge of SDCLK (SDR timing). DAT[3:0] shall be high within 1ms from start of providing SDCLK. Host check whether DAT[3:0] is high after 1ms from supplying SDCLK. This means that 1ms is the maximum for the card and the minimum for the host.

4.4 Electrical Characteristics

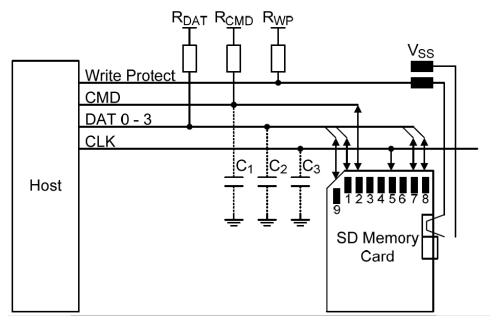


Figure 4-7: SD Card Connection Diagram

4.4.1 Absolute Maximum Conditions

Table 4-5: Absolute Maximum Conditions

Item	Symbol	Value	Unit
Supply Voltage	Vdd	-0.3 to 3.9	V
Input Voltage	Vin	-0.3 to V _{DD} +0.3 (≤3.9)	V

4.4.2 DC Characteristics

Table 4-6: DC Characteristics Threshold level for High Voltage Range)

Item		Symbol	Condition	MIN.	Тур.	MAX.	Unit	Note
Supply Vol	tage	VDD	-	2.7	-	3.6	V	
Input Voltage	High Level	VIH	-	VDD* 0.625	-	VDD+0.3	V	
, , , , , ,	Low Level	VIL	-	VSS- 0.3	-	VDD*0.25	V	
OutputVoltage	High Level		VDD = Min IOH = -2mA	VDD* 0.75	-	-	V	
,	Low Level	VOL	VDD = Min IOL= 2mA	-	-	VDD*0.125	V	
Input Voltage Se	etupTime	Vrs	-	-	-	250	ms	From 0V to VDDMIn

Table 4-7: Peak Voltage and Leakage Current

Parameter	Symbol	Min	Max.	Unit	Remarks
Peak voltage on all lines		-0.3	VDD+0.3	V	
All Inputs					
Input Leakage Current		-10	10	uA	
All Outputs					
Output Leakage Current		-10	10	uA	

Table 4-8: DC Characteristics (Threshold level for 1.8V signaling)

lte	em	Symbol	MIN.	MAX.	Unit	Condition
Supply	Voltage	VDD	2.7	3.6	V	
Regulato	or Voltage	VDDIO	1.7	1.95	٧	Generated by VDD
Input	High Level	VIH	1.27	2.00	V	
Voltage	Low Level	VIL	Vss-0.3	0.58	V	
Output	High Level	VOH	1.4	-	V	IOH=2mA
Voltage	Low Level	VOL	-	0.45	V	IOL=2mA

Table 4-9: Input Leakage Current for 1.8V Signaling

Parameter	Symbol	Min	Max.	Unit	Remarks
Input Leakage Current		-2	2	uA	DAT3 pull-up is disconnected

Table 4-10: Power Consumption

Item	Symbol	Condition	MIN.	Тур.	MAX.	Unit	Note
Standby Current	ICCS	3.6V Clock Stop	-	-	950	uA	@25 deg C
		CurrentLimit=400mA VDD = 3.6V	-	-	300		
Operation Current(peak)	ICCOP1 *1)	Current Limit=200mA VDD = 3.6V	-	-	300	mΑ	@25 deg C
		(HS or DS),VDD = 3.6V			300		
		Current Limit=400mA VDD = 3.6V			250		
Operation	ICCOP2	Current Limit=200mA VDD = 3.6V			200	mΑ	@25 deg C
Current(average)	*2)	SDR25 or HS VDD = 3.6V			200	ША	@25 deg C
		SDR12 or DS, VDD = 3.6V			100		
Input Voltage SetupTime	Vrs	-	-	-	250	ms	From 0V to VDDMIn

^{*1)} Peak Current: RMS value over a 10usec period *2) Average Current: value over 1 sec period.

Table 4-11: Signal Capacitance

Item	Symbol	Min.	Max.	Unit	Note
Pull up Resistance	RCMD RDAT	10	100	kΩ	
Total bus capacitance for each signal line	CL	ı	40	pF	1 cardCноsт+Св∪s≦30pF
Card capacitance for signal pin	CCARD	_	10	pF	
Pull up Resistance inside card (pin1)	RDAT3	10	90	kΩ	
Capacity Connected to Power line	CC	_	5	pF	

Note: WP pull-up (Rwp) Value is depend on the Host Interface drive circuit.

4.4.3 AC Characteristics (Default Speed)

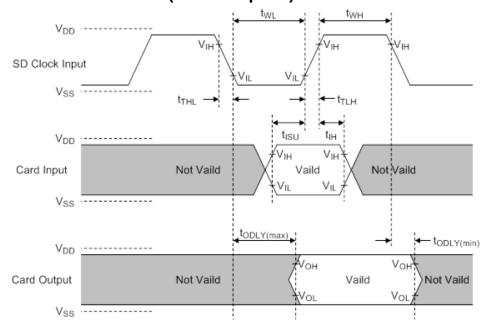


Figure 4-8: AC Timing Diagram (Default Speed Mode)

Table 4-12: AC Characteristics (Default Speed)

ltem	Symbol	Min.	Max.	Unit	Note
Clock Frequency (In any Sates)	fsty	0	25	MHz	CCARD ≦ 10pF (1Card)
Clock Frequency (Data transfer Mode)	fPP	0	25	MHz	
Clock Frequency (Card identification Mode)	fOD	0/100 *1)	400	kHz	
Clock Low Time	tWL	10	_	ns	
Clock High Time	tWH	10	1	ns	
Clock Rise Time	tTLH	1	10	ns	
Clock Fall Time	tTHL	1	10	ns	
Input set-up Time	tISU	5	_	ns	
Input Hold Time	tIH	5	_	ns	
Output Delay time during DataTransfer Mode	tODLY	0	14	ns	CL ≦ 40pF (1Card)
Output Delay time during Identification Mode	tODLY	0	50	ns	

^{*1) 0}Hz means to stop the clock. The given minimum frequency range is for cases were continues clock is required.

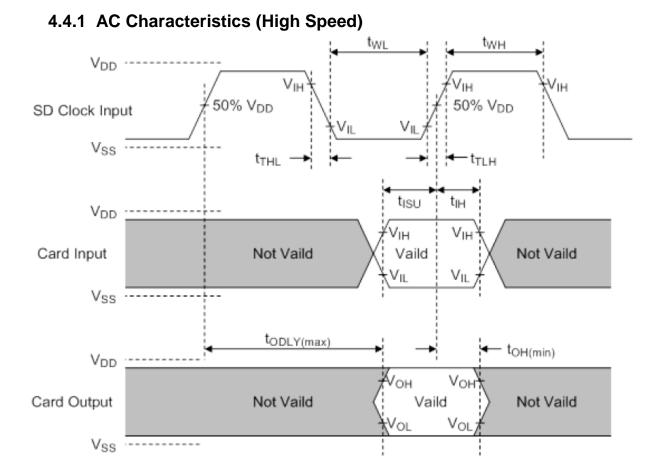


Figure 4-9: AC Timing Diagram (High Speed Mode)

Table 4-13: AC Characteristics (High Speed)

Item	Symbol	Min.	Max.	Unit	Note
Clock Frequency (During Data transfer)	fPP	0	50	MHz	Ccard≤10pF(1card)
Clock Low Time	tWL	7	_	ns	Ccard≤10pF(1card)
Clock High Time	tWH	7	_	ns	Ccard≤10pF(1card)
Clock Rise Time	tTLH	-	3	ns	Ccard≤10pF(1card)
Clock Fall Time	tTHL	-	3	ns	Ccard≤10pF(1card)
Input Setup Time	tISU	6	_	ns	Ccard≤10pF(1card)
Input Hold Time	tIH	2	_	ns	Ccard≤10pF(1card)
Output Delay Time	TODLY	_	14	ns	Ccard≤40pF(1card)
Output Hold Time	ТОН	2.5	-	ns	Ccard≤15pF(1card)

Item	Symbol	Min.	Max.	Unit	Note
Total System capacitance for each line	CL	-	40	рF	Ccard≤15pF(1card)

4.4.2 AC Characteristics (SDR104, SDR50, SDR25, SDR12)

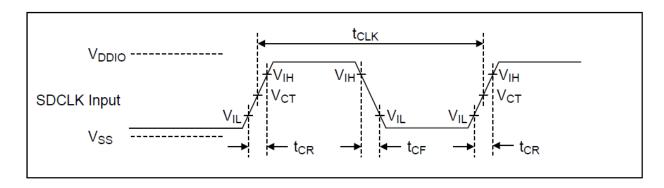


Figure 4-10: AC Timing Diagram (SDR104, SDR50, SDR25, SDR12 modes input)

Table 4-14: Clock Signal Timing of SDR104, SDR50, SDR25, SDR12 modes input

Symbol	Min.	Max.	Unit	Remark
tclk	4.80	-	ns	208MHz (Max.), Between rising edge, Vc⊤= 0.975V
tcr, tcf	-	0.2* tCLK	ns	tcr, tcr < 0.96ns (max.) at 208MHz, Ccard=10pF tcr, tcr, < 2.00ns (max.) at 100MHz, Ccard=10pF
Clock Duty	30	70	%	

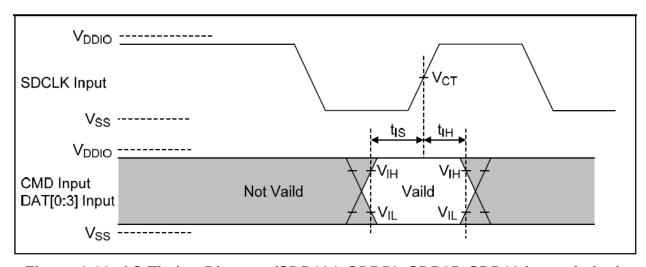


Figure 4-11: AC Timing Diagram (SDR104, SDR50, SDR25, SDR12 input timing)

Table 4-15: Clock input Timing of SDR104, SDR50, SDR25, SDR12 input timing

Symbol	Min.	Max.	Unit	SDR104 mode
tıs	1.40	-	ns	Ccard =10pF, Vct= 0.975V
tıн	0.80	-	ns	Ccard =5pF, Vct= 0.975V
Symbol	Min.	Max.	Unit	SDR12, SDR25 and SDR50 mode
tıs	3.00	-	ns	Ccard =10pF, Vct= 0.975V

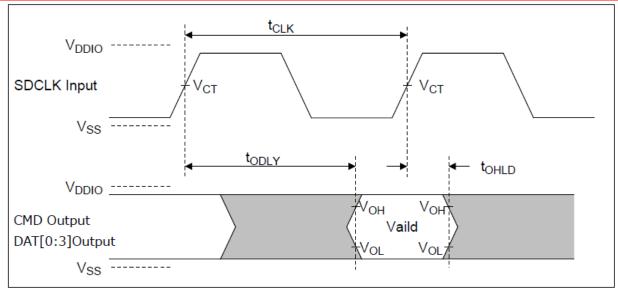


Figure 4-12: Output Timing of Fixed Window

Table 4-16: Output Timing of Fixed Data Window (SDR50, SDR25, SDR12)

Symbol	Min.	Max.	Unit	Remark
todly		7.5	ns	tclk>=10.0ns, Cl=30pF, using driver Type B, for SDR50
todly		14	ns	tclk>=20.0ns, Cl=40pF, using driver Type B, for SDR25 and SDR12
tон	1.5	-	ns	Hold time at the todly (min.), CL=15pF

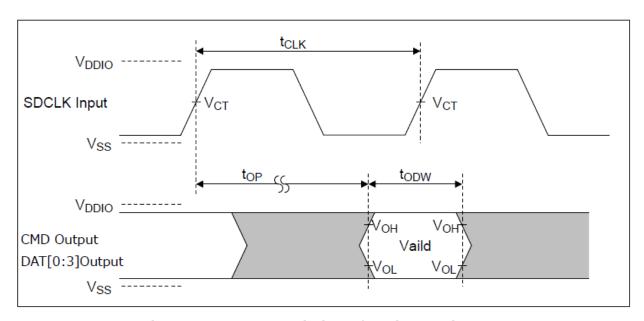


Figure 4-13: Output Timing of Variable Window

Table 4-17: Output Timing of Variable Data Window (SDR104)

Symbol	Min.	Max.	Unit	Remark					
top	0	2	UI	Card Output Phase					
Δtop	-350	+1550	ps	Delay variation due to temperature change after tuning					
todw	0.60	-	UI	todw=2.88ns at 208MHz					

Card ΔtOP is the total allowable shift of output valid window (tODW) from last system Tuning procedure. Card ΔtOP =1550pS for junction temperature of ΔT = 90°C during operation. Card ΔtOP =-350pS for junction temperature of ΔT = -20°C during operation.

6.4.5.2 Bus Timing Specification (DDR50)

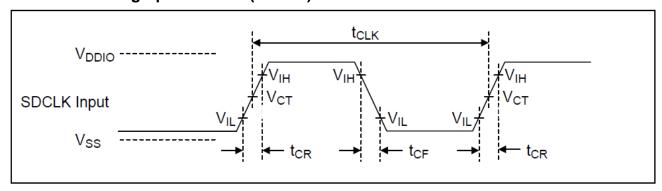


Figure 4-14: Clock Signal Timing

Table 4-18: Clock Signal Timing of DDR50

Symbol	Min.	Max.	Unit	Remark
tclk	20	-	ns	50MHz (Max.), Between rising edge
tcr, tcf	-	0.2* t clк	ns	tcr, tcr, < 4.00ns (max.) at 50MHz, Ccard=10pF
Clock Duty	45	55	%	

CMD signal timings are not shown in the figure below but For CMD signal timing refers to Figure 4-13 (Card Input Timing) and Figure 4-14 (Output Timing of Fixed Data Window) for Timing Diagram of SDR mode).

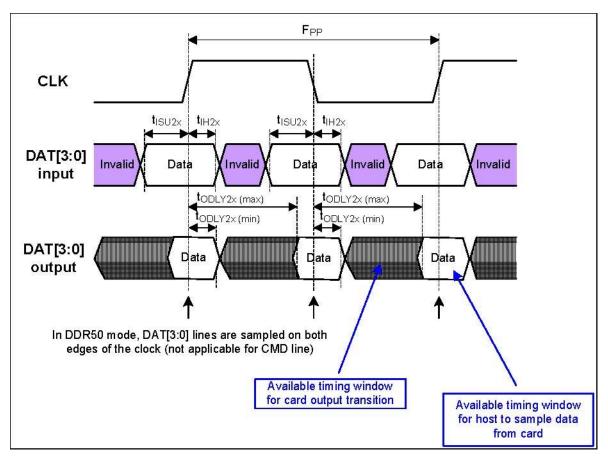


Figure 4-15: Timing Diagram DAT Inputs/Outputs Referenced to CLK in DDR50 Mode

Table 4-19: BUS Timings – Parameters Values (DDR50 mode)

Parameter	Symbol	Min	Max	Unit	Remark			
Input CMD (referenced to CLK	rising ed	lge)						
Input set-up time (*)	tısu	6	-	ns	Ccard ≤ 10 pF (1 card)			
Input hold time	tıн	0.8	-	ns	Ccard ≤ 10 pF (1 card)			

Parameter	Symbol	Min	Max	Unit	Remark					
Output CMD (referenced to CLK rising edge)										
Output Delay time during Data Transfer Mode	todly	-	13.7	ns	C∟ ≤ 30 pF (1 card)					
Output hold time	tон	1.5	-	ns	C∟ ≥ 15pF (1 card)					
Inputs DAT (referenced to CLK	rising a	nd fa	lling e	dge	s)					
Input set-up time	tısu2x	3	-	ns	Ccard ≤ 10 pF (1 card)					
Input hold time	t _{IH2x}	0.8	-	ns	Ccard ≤ 10 pF (1 card)					
Outputs DAT (referenced to CL	.K rising	and f	alling	j edg	jes)					
Output Delay time during Data Transfer Mode	todly2x		7.0	ns	C∟ ≤ 25 pF (1 card)					
Output hold time	todly2x	1.5	-	ns	C∟ ≥ 15pF (1 card)					

^(*) Input set-up time: tISU(min) is 6ns in PHYSICAL LAYER SPECIFICATION Ver.3.01

5 Card Internal Information

5.1 Security Information

MKB (Media Key Block) and Media ID are Standard Information. This information is in compliance with the CPRM.

Note: The security information is NOT Development information for evaluation. The Host System shall be compliance with the CPRM to use the security function. This information is kept as confidential because of security reasons.

5.2 SD Card Registers

The device has six Registers and two Status information: OCR, CID, CSD, RCA, DSR, SCR and SD Card Status, SD Status as same as SD card.

DSR IS NOT SUPPORTED in this card.

There are two types of register groups.

- MMC compatible registers: OCR, CID, CSD, RCA, DSR, and
- SCR SD card Specific: SD Status

Table 5-1: SD card Registers

Register Name	Bit Width	Description
CID	128	Card Identification number
RCA	16	Relative Card Address
DSR	16	Optional : Driver Stage
CSD	128	Card Specific Data
SCR	64	SD Configuration
OCR	32	Operation conditions
CSR	32	Card Status
CMD6	512	Switch Function Status
SD Status	512	Status bits and card features

5.2.1 OCR Register

This 32-bit register describes operating voltage range and status bit in the power supply.

Table 5-2: OCR Register Definition

OCR bit	00	D Fields Definition			Response Value				
position	OCR Fields Definition		32GB						
0-3		reserved	0	0	0				
4-6		reserved	0	0	0				
7		Reserved for Low Voltage Range	0	0	0				
8-14		reserved	0	0	0				
15		2.7 - 2.8	1	1	1				
16	VDD	2.8 - 2.9	1	1	1				
17	voltage Window	2.9 - 3.0	1	1	1				
18	vviildow	3.0 - 3.1	1	1	1				
19		3.1 - 3.2	1	1	1				
20		3.2 - 3.3	1	1	1				
21		3.3 - 3.4	1	1	1				
22		3.4 - 3.5	1	1	1				
23		3.5 - 3.6	1	1	1				
24(1)	Switc	ching to 1.8V Accepted (S18A)	1	1	1				
25-29		reserved	0 0 0						
30	Card C	Capacity Status (CCS)(2)		0=SD Memory Card, 1= (SDHC or SDXC)					
31	Card po	wer up status bit (busy)(3)			" 0 " = busy " 1 " = ready				

Notes:

- 1. bit24: Only UHS-I card supports this bit.
- 2. bit30: This bit is valid only when the card power up status bit is set.
- 3. bit31: This bit is set to LOW if the card has not finished the power up routine.
 - bit 23-4: Describes the SD Card Voltage
 - bit 31 indicates the card power up status. Value "1" is set after power up and initialization procedure completed.

5.2.2 CID Register

The CID (Card Identification) register is 128-bit width. It contains the card identification information. The Value of CID Register is vender specific.

Table 5-3: CID register

Field	Width	CID-		Initial Value		Comment
rieia	wiatn	slice	32GB	64GB	128GB	Comment
MID	8	[127:120]		0x02		Manufacture ID(0x02 = Toshiba)
OID	16	[119:104]		0x544D		OEM/Application ID (0x544D("TM") = Toshiba)
						32GB:"UC0D5"
PNM	40	[103:64]	0x5543304435	0x5543304535	0x5543304635	64GB:"UC0E5"
						128GB:"UC0F5"
PRV	8	[63:56]		0x52		Product Revision
PSN	32	[55:24]		0xnnnnnnnn		Product serial number
-	4	[23:20]		0x0		reserved
MDT	12	[19:8]		0xmmm		Manufacturing data ¹
CRC	7	[7:1]		CRC		CRC 7 Checksum (chapter 7, SD Physical spec
-	1	[0:0]		0x1		not used, always 1

Notes:

CID-Slice [11:8] Month Field (Exp. 1h = January)

CID-Slice [19:12] Year Field (Exp. 0h = 2000)

5.2.3 CSD Register

CSD is Card-Specific Data register provides information on 128bit width. Some field of this register can writable by PROGRAM_CSD (CMD27).

Table 5-4: CSD register

Field		VA/i altha	Cell	CSD-		Initial Va	lue	Commont
		Width	Туре	slice	32GB	64GB	128GB	Comment
CSD_STRUC	CTURE	2	R	[127:126]				CSD version 2.0(High Capacity and Extended Capacity)
-		6	R	[125:120]		00_0000)b	reserved
TAAC		8	R	[119:112]		0000_111	10b	1ms(time unit) * 1.0(time value) = 1ms
NSAC		8	R	[111:104]		0000_000)0b	0 clock Cycle
	SDR104				0010_	1011b		200Mbit/s
	SDR50				0000_	1011b		100Mbit/s
	DDR50				0000_	1011b		100Mbit/s
TRAN_SPEED	SDR25	8	R	[103:96]	0101_	0101_1010b		50Mbit/s
	SDR12				0011_0010b			25Mbit/s
	HS				0101_	0101_1010b		50Mbit/s
	DS				0011_	0010b		25Mbit/s

^{1.} The manufacturing date composed of two-hexadecimal digits.

		Cell	CSD-	In	Initial Value		
Field	Width	Туре	slice			128GB	Comment
CCC	12	R	[95:84]	0101	_1011_	0101b	Class 0,2,4,5,7,8,10 are supported
READ_BL_LEN	4	R	[83:80]		1001b	ı	512Bytes
READ_BL_PARTIAL	1	R	[79:79]		0		" 0 ": Partial block read is inhibited and only unit of block access is allowed.
WRITE_BLK_MISALIG N	1	R	[78:78]		0		" 0 " : Not allowed on this card
READ_BLK_MISALIGN	1	R	[77:77]		0		" 0 " : Invalid on this card
DSR_IMP	1	R	[76:76]		0		" 0 " :DSR NOT implemented
-	6	R	[75:70]	(000_000	Ob	reserved
C_SIZE	22	R	[69:48]	EE87h	1DD17h	3B9EFh	memory capacity = (C_SIZE+1) * 512K byte
-	1	R	[47:47]		0		reserved
ERASE_BLK_EN	1	R	[46:46]		1		" 1 " :Can erase by WRITE_BL_LEN unit (512 Bytes)
SECTOR_SIZE	7	R	[45:39]	1	11_111	1b	This size of an erasable sector. This field is fixed to 7F-h. Sector size = 64KBytes.
WP_GRP_SIZE	7	R	[38:32]	0	000_000b		This size of a write protected group. This field is fixed to 00-h. 1 Write Protect Group = 1sector.
WP_GRP_ENABLE	1	R	[31:31]		0		value of 0 means no group write protection possible.
-	2	R	[30:29]		00b		reserved
R2W_FACTOR	3	R	[28:26]		010b		This field is fixed to "2-h", which indicates 4 multiples. However, host should not use this factor and should use 250ms for write timeout.
WRITE_BL_LEN	4	R	[25:22]		1001b	1	" 9 ": 512Bytes on this card.
WRITE_BL_PARTIAL	1	R	[21:21]		0		" 0 ": Only the WRITE_BL_LEN size or 512Bytes are available
-	5	R	[20:16]		0_0000	b	reserved
FILE_FORMAT_GRP	1	R	[15:15]		0		This field is set to "0". Host should not use this field.
COPY	1	R/W	[14:14]		0		" 0 " : Original on this card
PERM_WRITE_PROTE CT	1	R/W	[13:13]	0			" 0 ": Not protected / Writable on this card
TMP_WRITE_PROTEC T	1	R/W	[12:12]		0		" 0 ": Not protected / Writable on this card
FILE_FORMAT	2	R	[11:10]		00b		" 0 ": Hard disk-like file system with partition table on this card.
-	2	R	[9:8]		00b		reserved

Field	Width	Cell	CSD-		nitial Val		Comment
Field	rieid wiatr		slice	32GB	64GB	128GB	Comment
CRC	7	R/W	[7:1]		CRC		CRC 7 Checksum
-	1	-	[0:0]		1		not used, always 1

Notes:

1.Cell Types: R: Read Only, R/W: Writable and Readable, R/W(1): One-time Writable / Readable 2. Erase of one data block is not allowed in this card. This information is indicated by "ERASE_BLK_EN".

Host System should refer this value before one data block size erase.

5.2.4 RCA Register

The writable 16bit relative card address register carries the card address in SD Card mode.

5.2.5 DSR Register

This register is not used

5.2.6 SCR Register

CR(SD Card Configuration Register) provides information on SD Memory Card's special features. The size of SCR Register is 64 bit and al bits are read only

Table 5-5: The SCR Fields

Field	Width	SCR- slice		itial Val 64GB 1		Comment
SCR_STRUCTURE	4	[63:60]		0x0		SCR version 1.0(Version 1.01-3.00)
SD_SPEC	4	[59:56]				" 2 " : Version 2.00 or Version 3.0X, Version 4.xx (Refer to SD_SPEC3 and SD_SPEC4)
DATA_STAT_AFTER_ERASE	1	[55:55]		0x1		" 1 " : on this card
SD_SECURITY	3	[54:52]	0x3	0x4		"3": Security Version 2.00 "4": Security Version 3.00
SD_BUS_WIDTHS	4	[51:48]		0x5		" 0101 " : 1 and 4 bit supported
SD_SPEC3	1	[47:47]		0x1		" 1 " : Version 3.0X, Version 4.xx (Refer to SD_SPEC4)
EX_SECURITY	4	[46:43]		0x0		Extended Security is not supported.
SD_SPEC4	1	[42:42]		0x1		" 1 " : Version 4.xx
-	6	[41:36]	0x0			reserved
CMD_SUPPORT	4	[35:32]	0x3			" 11 " : CMD23 and CMD20 support
-	32	[31:0]	0х	3202nn	inn	reserved for manufacture usage

Note: All bits are read only

5.2.7 Card Status

This field is intended to transmit the card's status information to the host.

Table 5-6: Card Status

Identifier	Bits	Type Va	lue

Identifier	Bits	Туре	Value		
OUT_OF_RANGE	31	E R X	" 0 " = no error , " 1 " = error		
ADDRESS_ERROR	30	E R X	" 0 " = no error , " 1 " = error		
BLOCK_LEN_ERROR	29	E R X	" 0 " = no error , " 1 " = error		
ERASE_SEQ_ERROR	28	ΕR	" 0 " = no error , " 1 " = error		
ERASE_PARAM	27	E R X	" 0 " = no error , " 1 " = error		
WP_VIOLATION	26	E R X	" 0 " = not protected , " 1 " = protected		
CARD_IS_LOCKED	25	SX	" 0 " = card unlocked , " 1 " = card locked		
LOCK_UNLOCK_FAILED	24	E R X	" 0 " = no error , " 1 " = error		
COM_CRC_ERROR	23	ΕR	" 0 " = no error , " 1 " = error		
ILLEGAL_COMMAND	22	ΕR	" 0 " = no error , " 1 " = error		
CARD_ECC_FAILED	21	E R X	" 0 " = success , " 1 " = failure		
CC_ERROR	20	E R X	0 " = no error , " 1 " = error		
ERROE	19	E R X	0 " = no error , " 1 " = error		
-	18		reserved		
-	17		reserved for DEFERRED_RESPONSE		
CSD_OVERWRITE	16	E R X	" 0 " = no error , " 1 " = error		
WE_ERASE_SKIP	15	E R X	" 0 " = not protected , " 1 " = protected		
CARD_ECC_DISABLED	14	SX	" 0 " = enabled , " 1 " = disabled		
ERASE_STATE	13	SR	" 0 " = cleared , " 1 " = set		
CURRENT_STATE	12 – 9	SX	" 0 " = idle , " 1 " = ready , " 2 " = ident , " 3 " = stanby " 4 " = tran , " 5 " = data " 6 " = rcv , " 7 " = prg " 8 " = dis , " 9 – 14 " = reserved " 15 " = reserved for la mode		
READY_FOR_DATA	8	SX	" 0 " = not ready , " 1 " = ready		
-	7,6		-		
APP_CMD	5	SR	" 0 " = Disabled , " 1 " = Enabled		
-	4		reserved for SD I/O Card		
AKE_SEQ_ERROR	3	ΕR	R " 0 " = no error , " 1 " = error		
-	2		reserved		
-	1,0		reserved		

Notes:

E: Error bit , S: Status bit , R: Detected and set for actual command response. X: Detected and set during command execution.

5.2.8 SD Status

Table 5-7: SD Status

Field	SD Initial Value Field Width Type Status -			Comment			
rield	Widtii	Турс	slice	32GB	64GB 128GB		Comment
					00b		1bit: HS1bit, SD1bit, HSSPI, SPI
DAT_BUS_WIDTH	2	SR	[511:510]	10b			4bit: SDR104, DDR50, SDR50, SDR25, SDR12, HS4bit, SD4bit
SECUERED_MODE	1	SR	[509]		1		Secured Mode
reserved	8		[508:502]	(00x0		reserved
reserved	6		[501:496]	(00x0		reserved
SD_CARD_TYPE	16	SR	[495:480]	0:	x0000		Regular SD RD/WR card
SIZE_OF_PROTECTED_AREA	32	SR	[479:448]	0x05000000	0x05000000 0x08000000		32GB:81,920KB 64GB:131,072KB 128GB:131,072KB
SPEED_CLASS	8	SR	[447:440]	0x04			Class10
PERFORMANCE_MOVE	8	SR	[439:432]	0x02 0x00			0x02:2MB/s、0x00:0MB/s
AU_SIZE	4	SR	[431:428]		0x9		0x9:4MB
reserved	4		[427:424]		0x0		reserved
ERASE_SIZE	16	SR	[423:408]	0:	x0020		32AU
ERASE_TIMEOUT	6	SR	[407:402]	(0x01		1sec
ERASE_OFFSET	2	SR	[401:400]	11b			3sec
UHS_SPEED_GRADE	4	SR	[399:396]	0x3			0x3:30MB/sec and above
UHS_AU_SIZE	4	SR	[395:392]	0xC			0xC:16MB
-	80		[391:312]	ALL 0			reserved
-	312		[311:0]	ALL 0			reserved for manufacture

S : Status bit , R : Set based on Command Response

5.2.9 Switch Function Status

Switch function command (CMD6) is used to switch or expand memory card functions. Currently four function groups are defined:

- (1) Access Mode: Selection of SD bus interface speed modes.
- (2) Command System: A specific function can be extended and controlled by a set of shared commands.
- (3) Driver Strength Selection of suitable output driver strength in UHS-I modes depends on host environment.
- (4) Power Limit Selection to limit the maximum power depends on host power supply capability and heat release capability.

Table 5-8: Switch Function Status

			Bus	Set Value	Value			
Description	Width	Bits	Speed Mode	of Gr4	32GB	64GB	128GB	
				0x0	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	
				0x1	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	
			SDR104/ SDR50/ DDR50	0x2	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	
				0x3	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	
Maximum Current Consumption	16	[511:496]		0x4	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	0x00FA (0.90W/250mA)	
Concumption			SDR25	0x0~0x4	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	
			SDR12	0x0~0x4	0x0064 (0.36W/100mA)	0x0064 (0.36W/100mA)	0x0064 (0.36W/100mA)	
			HS	0x0	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	0x00C8 (0.72W/200mA)	
			DS	0x0	0x0064 (0.36W/100mA)	0x0064 (0.36W/100mA)	0x0064 (0.36W/100mA)	
Function Gr 6, information.	16	[495:480]	-	-	0x8001			
Function Gr 5, information.	16	[479:464]	-	-	0x8001			
Function Gr4,	16	[463:448]	SDR104- 12 DDR50	-	0x801F			
information.			HS,DS	-		0x8001		
Function Gr3,	16	[447:432]	SDR104- 12 DDR50	-	0x800F			
information.			HS,DS	-	0x8001			
Function Gr 2, information.	16	[431:416]	-	-	0x8001			
Function Gr1, information.	16	[415:400]	SDR104- 12 DDR50	-	0x801F			

Description	Width	Bits	Bus Speed	Set Value	Value					
Description	wiatn	DIIS	Mode	of Gr4	32GB	64GB	128GB			
			HS,DS	-	0x8003					
Function Gr6, information.	4	[399:396]	-	-	Set Response Value					
Function Gr5, information.	4	[395:392]	-	-	;	Set Response Val	ue			
Function Gr4, information.	4	[391:388]	-	-	;	Set Response Val	ue			
Function Gr3, information.	4	[387:384]	-	-	;	Set Response Val	ue			
Function Gr2, information.	4	[383:380]	-	-	Set Response Value					
Function Gr1, information.	4	[379:376]	-	-	Set Response Value					
Data Structure Version	8	[375:368]	-	-	0x00					
Busy Status of functions in Gr6	16	[367:352]	-	-	0x0000					
Busy Status of functions in Gr5	16	[351:336]	-	-	0x0000					
Busy Status of functions in Gr4	16	[335:320]	-	-	0x0000					
Busy Status of functions in Gr3	16	[319:304]	-	-	0x0000					
Busy Status of functions in Gr2	16	[303:288]	-	-	0x0000					
Busy Status of functions in Gr1	16	[287:272]	-	-	0x0000					
Reserved	272	[271:0]	-	-	ALL 0					

5.3 Logical Format

The SD card is formatted before shipping to be compliant to the SD Card FILE SYSTEM SPECIFICATION. The following parameters may be changed if the host system is not compliant with the SD Card Format Specification. The data of the logical format is described in section 5.3.3 (128GB Card), section 5.3.4 (64GB Card) and section 5.3.5 (32GB Card).

5.3.1 SD card Capacities

Table 5-9: SD Card capacities

	Card Capacities									
Item	32GB		64G	В	128GB					
	Sector	КВ	Sector	КВ	Sector	КВ				
Whole Capacity	62,660,608	31,330,304	125,231,104	62,615,552	250,331,136	125,165,568				
User Data Area Size	62,529,536	31,264,768	125,067,264	62,533,632	250,068,992	125,034,496				
Protected Area Size	131,072	65,536	163,840	81,920	262,144	131,072				

5.3.2 SD card System Information

Table 5-10: SD Card System information

	Item	Card Capacities					
	Item	32GB	64GB	128GB			
User Data	Data Boundary unit size (KB)	4,096	16,384	16,384			
Area	Cluster Size (KB)	32	128	128			
Protected	Data Boundary unit size (KB)	16	16	16			
Area	Cluster Size (KB)	16	16	16			

5.3.3 Data of the logical format of a 128GB Card

(Contact Viking)

5.3.4 Data of the logical format of a 64GB Card

(Contact Viking)

5.3.5 Data of the logical format of a 32GB Card

(Contact Viking)

6 SD Specification Compliance

1) Non Supported Registers:

DSR Register (Optional register: PHISYCAL LAYER SPECIFICATION 5.5)

2) Non Supported Functions:

Programmable Card Output Driver (Optional in PHYSICAL LAYER SPECIFICATION 6.5) Card 's Internal Write Protect (Optional in PHYSICAL LAYER SPECIFICATION 4.3.6.)

3) Non Specified Command:

CMD4 SET_DSR CMD28 SET_WRITE_PROT CMD29 CLR_WRITE_PROT CMD30 SEND_WRITE_PROT CMD56 GEN_CMD

7 Reliability Guidance

This reliability guidance is intended to provide some guidance related to using raw NAND flash. Although random bit errors may occur during use, it does not necessarily mean that a block is bad. Generally, a block should be marked as bad when a program status failure or erase status failure is detected. The other failure modes may be recovered by a block erase.

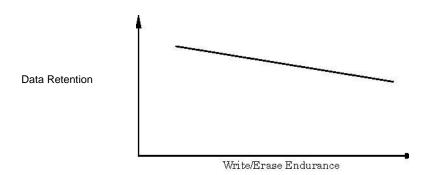
ECC treatment for read data is mandatory due to the following Data Retention and Read Disturb failures.

Write/Erase Endurance

Write/Erase endurance failures may occur in a cell, page, or block, and are detected by doing a status read after either an auto program or auto block erase operation. The cumulative bad block count will increase along with the number of write/erase cycles.

Data Retention

The data in memory may change after a certain amount of storage time. This is due to an electrical charge loss or charge gain. After block erasure and reprogramming, the block may become usable again. Also write/erase endurance deteriorates data retention capability. The figure below shows a generic trend of relationship between write/erase endurance and data retention.



Read Disturb

A read operation may disturb the data in memory. The data may change due to charge gain. Usually, bit errors occur on other pages in the block, not the page being read. After a large number of read cycles (between block erases), a tiny charge may build up and can cause a cell to be soft programmed to another state. After block erasure and reprogramming, the block may become usable again.

Considering the above failure modes, Viking recommends following usage model:

Avoid any excessive iteration of resets and initialization sequences (card identification mode) as far much as possible after power-on, which may result in read disturb failure. The resets include hardware resets and software resets. i.e.

1) The iteration of the following command sequence: CMD0 -ACMD41 (The assertion of ACMD41 implies a count of internal read operation in Raw NAND.

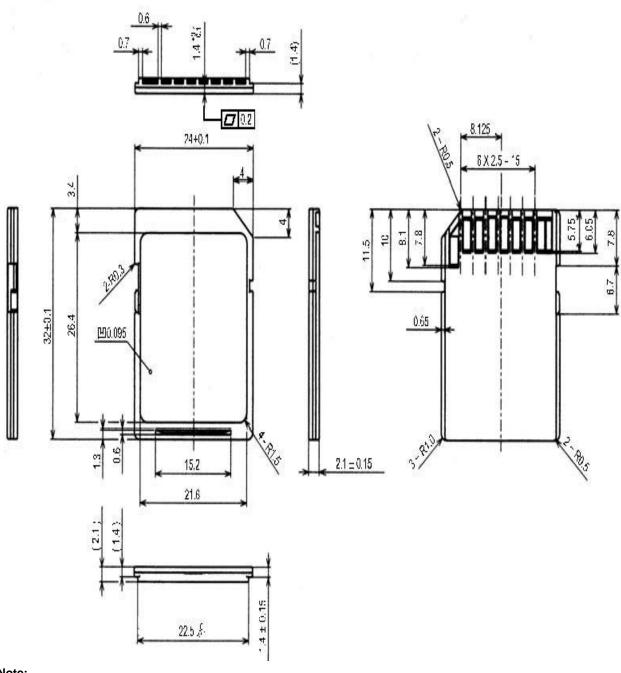
• CMD0: Go idle state command,

• ACMD41 : SD send operation command

2) Iteration of the following command: ACMD43

• ACMD43 : Get MKB command

8 SD Card Mechanical Dimensions



Note:

- 1. All dimensions in mm
- 2. Tolerance is \pm 0.15 mm